

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 6) V_{GS} = -10V	T _C = +25°C T _C = +70°C	۱ _D	-7.3 -5.8	A
Maximum Body Diode Forward Current (Note 6)		ls	-1.8	А
Pulsed Drain Current (380µs Pulse, 1% Duty Cycle)		I _{DM}	-24	А
Avalanche Current (Note 7) L = 0.1mH		I _{AS}	-19	А
Repetitive Avalanche Energy (Note 7) L = 0.1mH		E _{AS}	18	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	D	1.2	W
	T _A = +70°C	PD	0.75	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Р	105	°C/W
	t<10s	$R_{ heta JA}$	60	°C/W
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	Pn	1.8	W
	T _A = +70°C	PD	1.1	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	69	°C/W
Thermal Resistance, Junction to Ambient (Note 0)	t<10s	$R_{ heta JA}$	39	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{ ext{ heta}JC}$	15	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)			1	1	r		
Drain-Source Breakdown Voltage	BV _{DSS}	-60		—	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_		-1	μA	$V_{DS} = -48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_		100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	-1		-3	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance		_	—	105	05 mΩ	V _{GS} = -10V, I _D = -4.5A	
	R _{DS(ON)}	_	—	130	11152	$V_{GS} = -4.5V, I_D = -3.5A$	
Diode Forward Voltage	V _{SD}		-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	969	_		$V_{DS} = -30V, V_{GS} = 0V, f = 1.0MHz$	
Output Capacitance	Coss	_	57	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	44	_			
Gate Resistance	R _G	_	13.7	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	8.2	_		V _{DS} = -30V, I _D = -12A	
Total Gate Charge (V _{GS} = -10V)	Qg	_	17.2	_	nC		
Gate-Source Charge	Q _{gs}	_	3.0	_	nc		
Gate-Drain Charge	Q _{gd}	_	3.1	_			
Turn-On Delay Time	t _{D(ON)}		4.4	_		V_{GS} = -10V, V_{DS} = -30V, R_{GEN} = 3 Ω , I_D = -12A	
Turn-On Rise Time	t _R	_	23	_			
Turn-Off Delay Time	t _{D(OFF)}	_	34	_	ns		
Turn-Off Fall Time	tF		42	_			
Body Diode Reverse Recovery Time	t _{RR}		13.2	_	ns		
Body Diode Reverse Recovery Charge	Q _{RR}		6.18	—	nC	$I_{\rm S} = -12A$, dl/dt = 100A/µs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

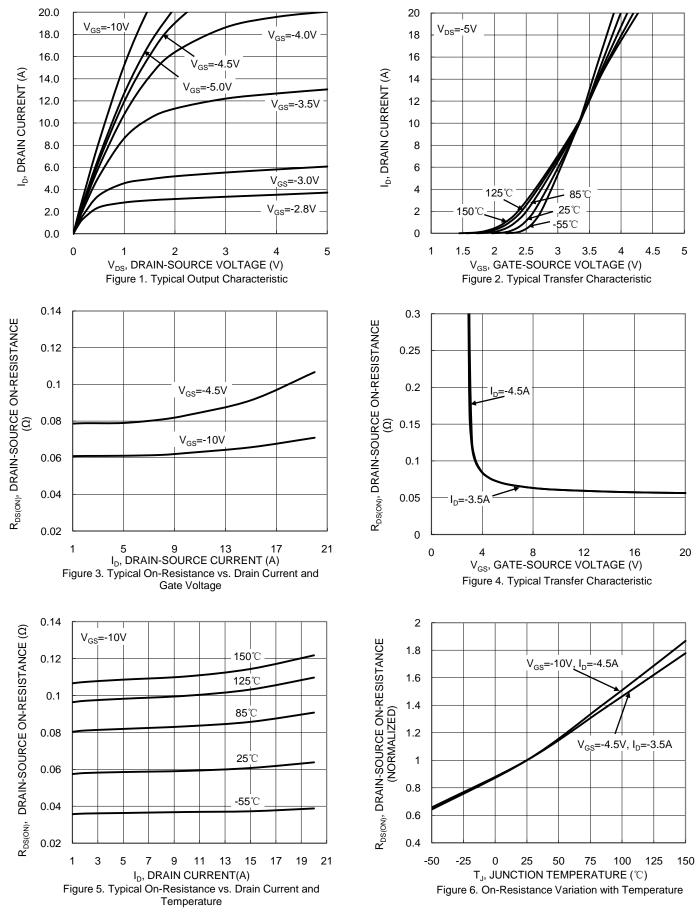
7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



DMP6110SVT



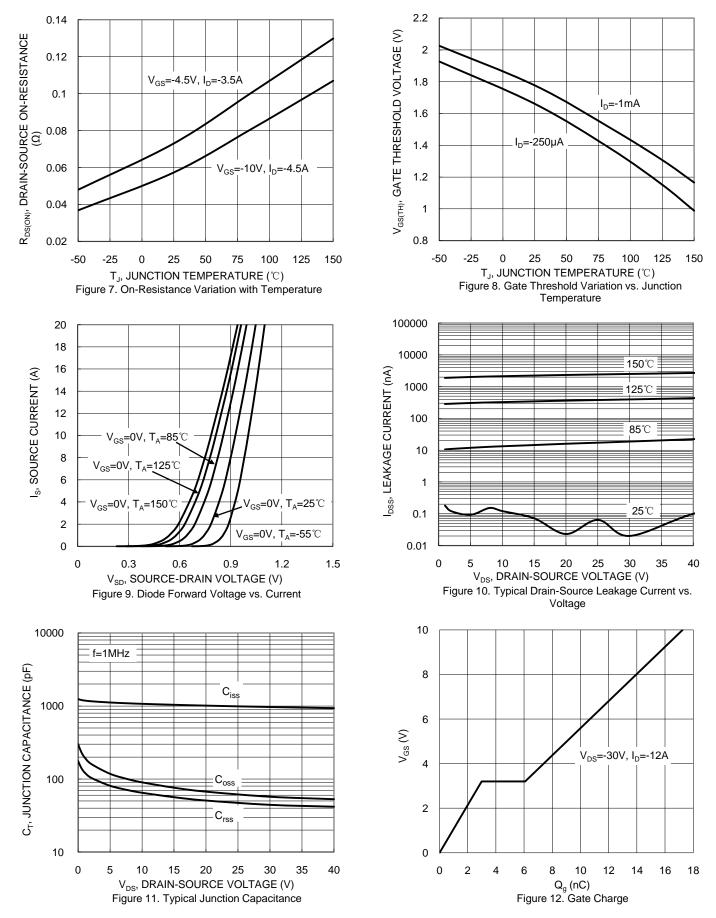
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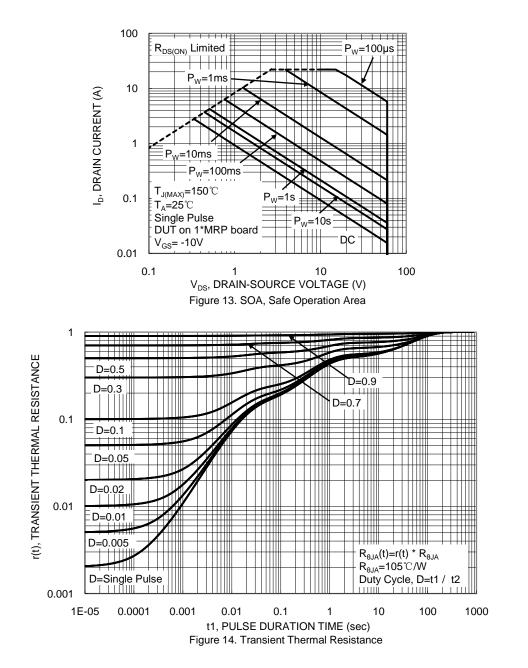


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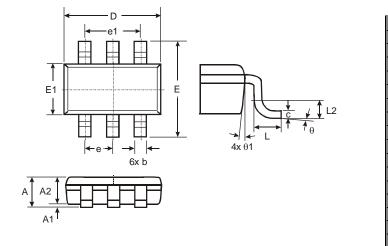


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Package Outline Dimensions

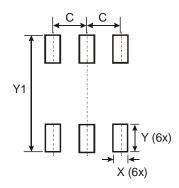
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TSOT26					
Dim	Min	Max	Тур		
Α	-	1.00	-		
A1	0.01	0.10	-		
A2	0.84	0.90	-		
D	-	-	2.90		
Е	_	-	2.80		
E1	-		1.60		
b	0.30	0.45	-		
С	0.12	0.20	-		
е	-	-	0.95		
e1	-	-	1.90		
L	0.30	0.50			
L2	-	-	0.25		
θ	0°	8°	4°		
θ1	4°	12°	—		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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